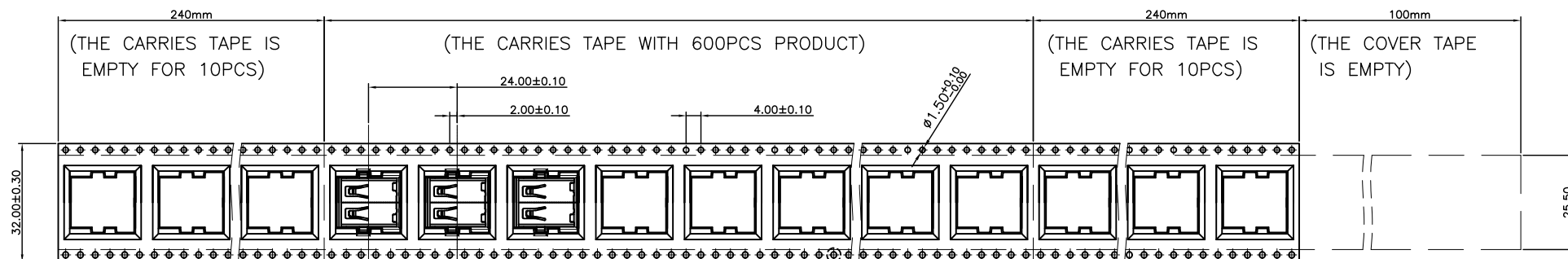


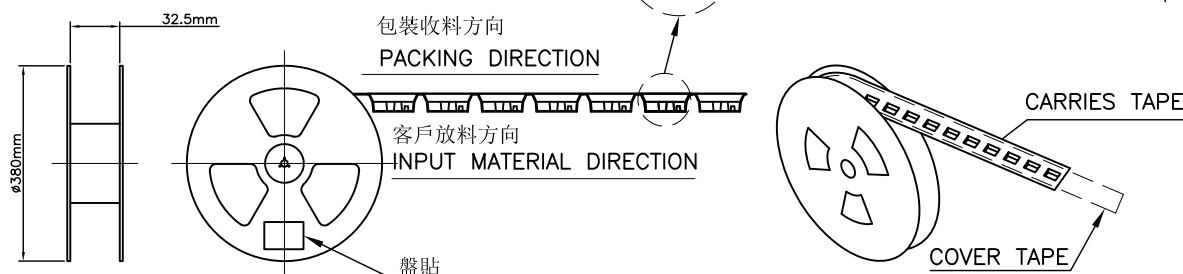
TOLERANCE:		DRAWN BY :	DATE :	PART NAME:	
X.X ±0.30		陈一鸣	2014-02-23	USB AF 板下DIP 沉板上1.66	
X.XX ±0.25					
X.XXX ±0.15					
X.* ±2* X.* ±0.5*		CHECKED BY:	DATE :	PART NO.	HYCW354-USBA04-166B
		马跃	2014-02-23	MOLD NO.	
UNIT: mm [inch]					
SCALE:1:1 SIZE: A4		APPROVED BY:	DATE :	DRAW NO:	HYC-2511171454
		邱敏	2014-02-23	SHEET NO.	1 OF 1



SCALE 2:1

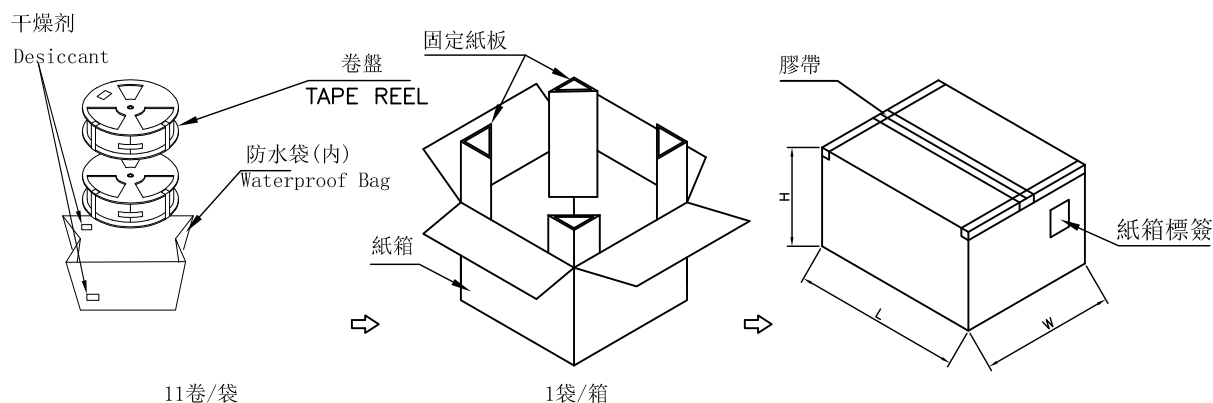
備注:

1. 防止漏裝，禁止碰歪產品錫腳。
2. 產品在CARRY TPAE中的方向須如圖所示。
3. COVER剝離力：0.1~1.3N。
4. 剝離角度為：165度~180度。
5. 剝離速度為：300mm/miunies。



⇒ (I/O DIRECTION)

600PCS/REEL (空前10PCS後10PCS)



 深圳市华宇创精密电子有限公司				
TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.' ±2" X.X" ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 包装图	
UNIT: mm [inch] SCALE:1:1 SIZE: A4	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	MOLD NO.
	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO:	SHEET NO. 1 OF 1